APPLICA	BLE STAN	DARD								
RATING	OPERATING TEMPERATURE RANGE		00°0 TO . 05°0 (NOTE 1)			ORAGE MPERATURE RANGE		-10°C TO + 60°C (NOTE		2)
	OPERATING HUMIDITY RANGE		40% TO + 80%		STORAGE HUMIDITY F	RANGE		40% TO + 70% (NO		
	VOLTAGE		250V AC			VOLTAGE		30V AC		
	CURRENT		AWG 22 TO 26 :	2A	UL · CSA RATING	CURRENT	_	AWG 22 :	2A	
	CORRENT		AWG 28 :	1 A		CORRENT	'	AWG 24 TO 28 :	1A	
). 5A				AWG 30 :	0. 5A	
			SPECI	FICAT	IONS					
	TEM		TEST METHOD			RE	EQU	IREMENTS	QT	AT
GONSTR GENERAL EX	RUCTION	MELIALI	AND BY MEASURING INSTRU	MENT	IACCC	DEDING TO) DB	AW/ING	Tv	ΙV
MARKING	AMINATION		TAND BY MEASURING INSTRUMENT.			ACCORDING TO DRAWING.			X	X
	IC CHARA								^	
	RESISTANCE		DC OR 1000 Hz).		30m	Ω MAX.			Τ.,	Ι
NCIII ATION	A.I	· ·	,						X	上
NSULATION RESISTANC		500V DC	500V DC.		1000	MΩ MIN.			X	-
/OLTAGE P	ROOF	650V AC	FOR 1 min.	R 1 min.		NO FLASHOVER OR BREAKDOWN.			X	_
MECHAN	VICAL CHA	RACTE	RISTICS						1	<u> </u>
		30 TIME	30 TIMES INSERTIONS AND EXTRACTIONS.					TANCE: 30mΩ MAX.	x	
					1	② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				-
VIBRATION			NCY 10 TO 55 Hz, SINGLE A		1 1 NO	ELECTRIC		DISCONTINUITY OF 1μs.	\ \ \	
SHOCK			AT 2 h, FOR 3 DIRECTION DURATION OF PULSE 11 m			DAMAGE PARTS.	, CR	ACK OR LOOSENESS	X	<u> </u>
J. IOOK			RECTIONS.			FARIO.			X	_
			ACTERISTICS		· .					
RAPID CHAI TEMPERATI			ATURE -55→5 TO 35→+85		1 -	ONTACT RE			X	
TEMPERATURE		TIME $30 \rightarrow 5$ TO 15 $\rightarrow 30$ $\rightarrow 5$ TO15 min UNDER 5 CYCLES.		3 NO	② INSULATION RESISTANCE: 1000MΩ MIN.③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					
DAMP HEAT (STEADY STATE)		EXPOSE	OSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.			 CONTACT RESISTANCE: 30mΩ MAX. INSULATION RESISTANCE: 500MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 			X	_
COUNT DES		ESCRIPTION	RIPTION OF REVISIONS DESIG		ESIGNED	GNED		CHECKED		ATE
Δ						\Box				
						APPROV	-	KI. AKIYAMA	11.0	
						DESIGN	-	HK. UMEHARA		2. 18
						DRAW	-	TH. YOSHIZAWA MI. SAKIMURA)2. 18)2. 18
Note QT:Qı	ualification Tes	t AT:Assi	urance Test X:Applicable Tes	st	DRΔ\Λ/I			ELC4-302590		رد. ۱۵
				ART NO.			F11CZ-12DS-2V (22)			
HS.			LECTRIC CO., LTD.			CI 1			Δ	1/2
ORM HD0011-				U	ODE NO.	UL	J40	ZUU1-1-ZZ	<u>. W</u>	1/2

	SPECIFICATIO	NS		
ITEM	TEST METHOD	REQUIREMENTS	QT	AT
RESISTANCE TO SOLDERING HEAT	1) AUTOMATIC SOLDERING (REFLOW) 《REFLOW AREA》 MAX 250°C WITHIN 10 sec. MIN 230°C WITHIN 60 sec. 《PREHEATING AREA》 150 TO 180°C 90 TO 120 sec. PUT THROUGH IN REFROW FUMACE TWICE. FEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. CONNECTOR TEMPERATURE TO BE AMBIENT FOR SECOND REFLOW. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :290±10°C, SOLDERING TIME :3s. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	×	
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 230±5°C FOR IN IMMERSION, DURATION, 3 s.	A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	X	
DEMADKS				

REMARKS

NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT.

NOTE 2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD,
AFTER PCB BOARD, OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERM
STORAGE DURING TRANSPORTATION.

NOTE 3:THE TEMPERATURE PROFILE SHALL BE APPLIED WITHIN 168 HOURS AFTER OPENING MOISTURE-PROOF PACKAGING. WHEN 168 HOURS PASSED AFTER OPENING , APPLY THE BOTTOM REQUIREMENTS.

《REFLOW AREA》

MAX 240°C WITHIN 10 sec. MIN 230°C WITHIN 60 sec. 《PREHEATING AREA》

150 TO 180°C 90 TO 120 s.

Unless otherwise specifid, refer to JIS C 5402.

Note QT:Qı	ualification Test AT:Assurance Test X:Applicable Test	DRAWING NO.		ELC4-302590-01		
HS	HRS SPECIFICATION SHEET		DF11CZ-12DS-2V(22)			
	HIROSE ELECTRIC CO., LTD.	CODE NO	CL543	3-2067-1-22	A	2/2